Amendments to the Claims

This listing of claims replaces all previous versions and listings of claims in this application.

- 1. (currently amended) A low-pressure discharge lamp comprising a tubular glass lamp vessel on an outer surface of which a conductor layer is formed as an electrode, wherein the conductor layer is a solder dipping layer formed by solder dipping and the solder dipping layer has a main component of any one of tin, an alloy of tin and indium, or an alloy of tin and bismuth.
- 2. (currently amended) A low-pressure discharge lamp according to claim 1, wherein the <u>conductor</u> solder dipping layer contains at least one of antimony, zinc, or aluminum as an additive.
- 3. (currently amended) A low-pressure discharge lamp according to claim 2, wherein a part of a surface of the tubular glass lamp vessel, where the <u>conductor</u> solder dipping layer is formed, is blasted.
- 4. (currently amended) A low-pressure discharge lamp comprising a tubular glass lamp vessel on an outer surface of which a conductor layer is formed as an electrode, wherein the conductor layer is an ultrasonic solder dipping layer formed by ultrasonic solder dipping.
- 5. (currently amended) A low-pressure discharge lamp according to claim 4, wherein the conductor ultrasonic solder dipping layer has a main component of any one of tin, an alloy of tin and indium, or an alloy of tin and bismuth.
- 6. (currently amended) A low-pressure discharge lamp according to claim 5, wherein the conductor ultrasonic solder dipping layer contains at least one of antimony, zinc, or aluminum as an additive.
- 7. (currently amended) A low-pressure discharge lamp according to claim 6, wherein a part of a surface of the tubular glass lamp vessel where the <u>conductor</u> ultrasonic solder dipping layer is formed is blasted.

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8. (currently amended) A low-pressure discharge lamp according to claim 7, wherein the <u>conductor ultrasonic solder dipping</u> layer contains no lead component.

9-20. (cancelled)